

December 2013

# **FDH44N50**

# N-Channel SMPS Power MOSFET

500 V, 44 A, 120 mΩ

# **Features**

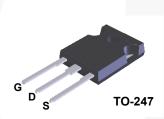
- ullet Low Gate Charge  $Q_g$  Results in Simple Drive Requirement (Typ. 90 nC)
- Improved Gate, Avalanche and High Reapplied dv/dt Ruggedness
- Reduced  $R_{DS(on)}$  (110 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 22 A)
- Reduced Miller Capacitance and Low Input Capacitance (Typ.  $C_{rss}$  = 40 pF)
- Improved Switching Speed with Low EMI
- 175°C Rated Junction Temperature

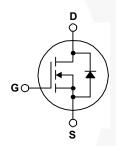
# Description

UniFET™ MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

# **Applications**

- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply





# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FDH44N50	Unit	
$V_{DSS}$	Drain to Source Voltage	500	V	
V <sub>GS</sub>	Gate to Source Voltage ±30		V	
I <sub>D</sub>	Drain Current			
	Continuous ( $T_C = 25^{\circ}C$ , $V_{GS} = 10 \text{ V}$ )	44	Α	
	Continuous ( $T_C = 100^{\circ}C$ , $V_{GS} = 10 \text{ V}$ )	32	Α	
	Pulsed <sup>1</sup>	176	Α	
Ъ	Power Dissipation	750	W	
$P_{D}$	Derate Above 25°C	5	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature	-55 to 175	°C	
	Soldering Temperature for 10 Seconds	300 (1.6mm from case)	°C	
Mounting Torque, 8-32 or M3 Screw		10ibf*in (1.1N*m)		

# **Thermal Characteristics**

Symbol	Parameter	FDH44N50	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.2	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W	

# **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDH44N50	FDH44N50	TO-247	Tube	N/A	N/A	30 units

# **Flectrical Characteristics**

Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit
atics						
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	$I_D$ = 250 $\mu$ A, $V_{GS}$ = 0 $V$	500	-	-	V
ΔB <sub>VDSS</sub> / ΔT <sub>.1</sub>	Breakdown Voltage Temp. Coefficient	Reference to 25°C, I <sub>D</sub> = 1 mA	-	0.61	-	V/°C
r <sub>DS(ON)</sub>	Drain to Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 22 A	-	0.11	0.12	Ω
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3.15	4	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 500 \text{ V}$ $T_{C} = 25^{\circ}\text{C}$ $T_{C} = 150^{\circ}\text{C}$	-	-	25 250	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±20 V	-	-	±100	nA
ynamics		, ==				
9 <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 22 A	11	-	-	S
Q <sub>g(TOT)</sub>	Total Gate Charge at 10V	V <sub>GS</sub> = 10 V,	-	90	108	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V <sub>DS</sub> = 400 V,	-	24	29	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	I <sub>D</sub> = 44 A	-	31	37	nC
t <sub>d(ON)</sub>	Turn-On Delay Time	$V_{DD} = 250 \text{ V},$	-/	16	-	ns
t <sub>r</sub>	Rise Time	$I_{D} = 44 \text{ A},$	- \	84	-	ns
t <sub>d(OFF)</sub>	Turn-Off Delay Time	$R_G = 2.15 \Omega$	-	45	-	ns
t <sub>f</sub>	Fall Time	$R_D = 5.68 \Omega$	-	79	-	ns
C <sub>ISS</sub>	Input Capacitance	V 05V V 0V	-	5335	-	pF
Coss	Output Capacitance	$V_{DS} = 25V, V_{GS} = 0 V,$ f = 1  MHz	-	645	-	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance	1 - 1 1011 12	-	40	-	pF
valanch	e Characteristics		•		•	-
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>		1500	-	-	mJ
I <sub>AR</sub>	Avalanche Current		-	-	44	Α
rain-Soເ	urce Diode Characteristics					
I <sub>S</sub>	Continuous Source Current (Body Diode)	MOSFET symbol showing the	- 7	-	44	А
I <sub>SM</sub>	Pulsed Source Current <sup>1</sup> (Body Diode)	integral reverse p-n junction diode.	-	-	176	А
V <sub>SD</sub>	Source to Drain Diode Voltage	I <sub>SD</sub> = 44 A	-	0.900	1.2	V
				1		

 $Q_{RR}$ 

1: Repetitive rating; pulse-width limited by maximum junction temperature. 2: Starting  $T_J$  = 25°C, L = 1.61 mH,  $I_{AS}$  = 44 A

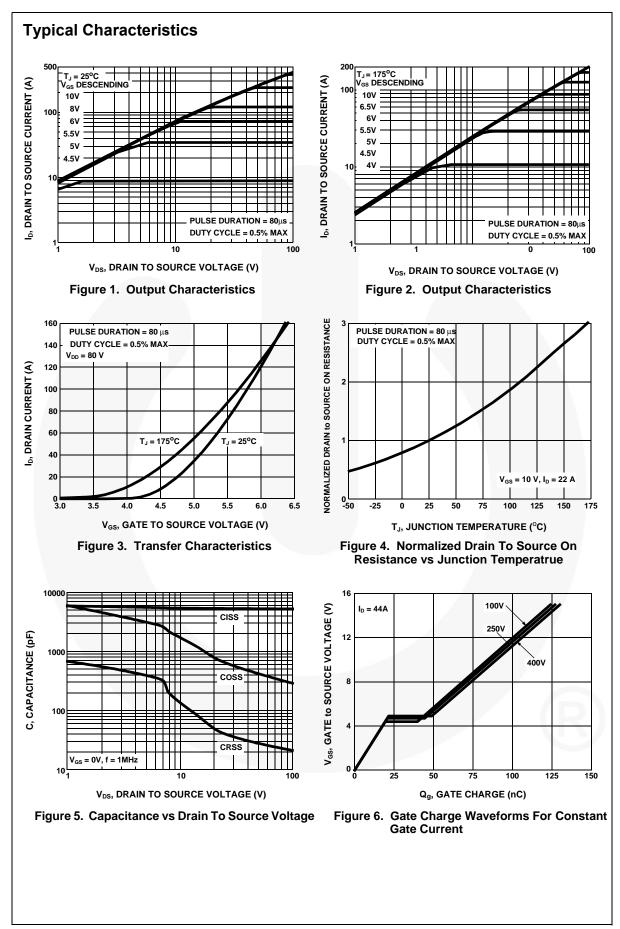
Reverse Recovered Charge

18

μС

14

 $I_{SD} = 44 \text{ A}, dI_{SD}/dt = 100 \text{ A/}\mu\text{s}$ 



# T<sub>J</sub> = 175°C T<sub>J</sub> = 25°C T<sub>J</sub>

Typical Characteristics (Continued)

OPERATION IN THIS AREA

OPERATION IN THIS AREA

IOU

IOU

IOU

VDS, DRAIN TO SOURCE VOLTAGE (V)

Figure 7. Body Diode Forward Voltage vs Body Diode Current

V<sub>SD</sub>, SOURCE TO DRAIN VOLTAGE (V)

Figure 8. Maximum Safe Operating Area

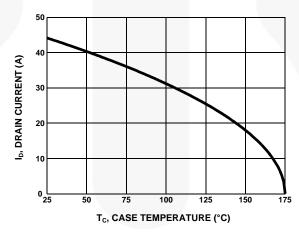


Figure 9. Maximum Drain Current vs Case Temperature

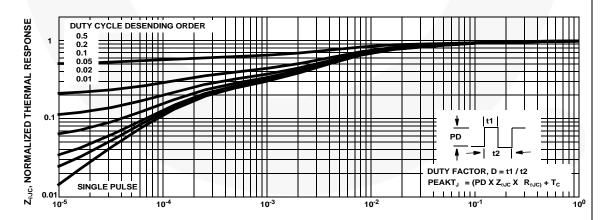


Figure 10. Normalized Transient Thermal Impedance, Junction to Case

t1, RECTANGULAR PULSE DURATION (S)

# **Test Circuits and Waveforms**

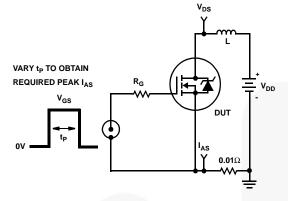


Figure 11. Unclamped Energy Test Circuit

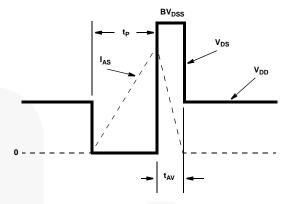


Figure 12. Unclamped Energy Waveforms

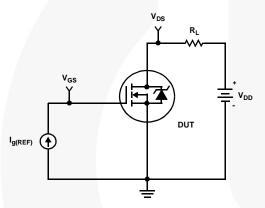


Figure 13. Gate Charge Test Circuit

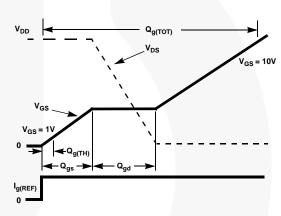


Figure 14. Gate Charge Waveforms

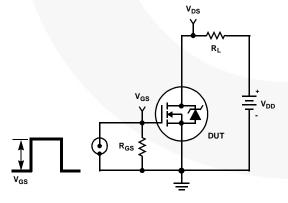


Figure 15. Switching Time Test Circuit

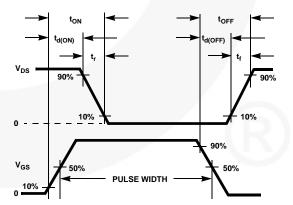
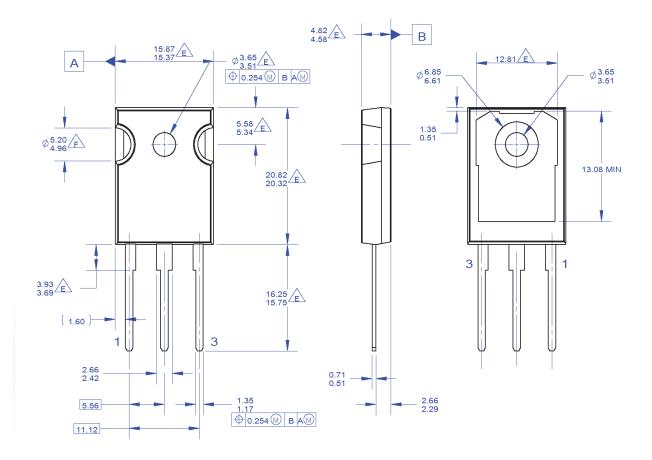


Figure 16. Switching Time Waveform

# **Mechanical Dimensions**



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE E, VARIATION AB, DATED JUNE, 2004.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
  D. DRAWING CONFORMS TO ASME Y14.5 1994

E DOES NOT COMPLY JEDEC STANDARD VALUE

NOTCH MAY BE SQUARE

DRAWING FILENAME: MKT-TO247A03\_REV03

# Figure 17. TO-247, Molded, 3-Lead, Jedec Variation AB

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